## PATENT ASSIGNMENT

# Electronic Version v1.1 Stylesheet Version v1.1

**SUBMISSION TYPE: NEW ASSIGNMENT** NATURE OF CONVEYANCE: **ASSIGNMENT** 

#### **CONVEYING PARTY DATA**

Name	Execution Date
Jhon Jhy Liaw	06/10/2010
Jeng-Jung Shen	06/11/2010

## **RECEIVING PARTY DATA**

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD	
Street Address:	No. 8, Li-Hsin Rd., 6, Science-Based Industrial Park	
City:	Hsin-Chu	
State/Country:	TAIWAN	
Postal Code:	300-77	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12827690

## **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER: 24061.1454

NAME OF SUBMITTER: Rachel Davis

Total Attachments: 2

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> **PATENT** REEL: 024921 FRAME: 0979

Docket No.: 2010-0193 / 24061.1454

Customer No.: 42717

#### ASSIGNMENT

WHEREAS, we,

(1) Jhon Jhy Liaw of No. 15, Lane 447, Xuefu E. Road Zhudong Township, Hsinchu County 310, Taiwan, R.O.C.

(2) Jeng-Jung Shen of No. 25, Huei Min Road, Nan Tzu District Kaohsiung City, Taiwan, R.O.C.

have invented certain improvements in

## LAYOUT FOR MULTIPLE-FIN SRAM CELL

for which we have executed an application for Letters Patent of the United States of America on June 30, 2010 as U.S. Serial No. 12/827,690 ; and

WHEREAS, we authorize the attorney of record to update this document to include Patent Office information as deemed necessary (i.e., filing date, serial number, etc.);

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd., ("TSMC"), No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, R.O.C. is desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said TSMC, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to the said TSMC, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

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AND WE HEREBY further covenant and agree that we will communicate to said TSMC, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said TSMC, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

Inventor Name:

Residence Address:

No. 15, Lane 447, Xuefu E. Road
Zhudong Township, Hsinchu County 310, Taiwan, R.O.C.

Dated:

Then Thy Lan W
Inventor Signature

Inventor Name:

Jeng-Jung Shen

Residence Address:

No. 25, Huei Min Road, Nan Tzu District
Kaohsiung City, Taiwan, R.O.C.

Dated:

Dated:

Inventor Signature

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